

Title (en)

IMPROVED MODULAR ASSEMBLY FOR COVERING A FLOOR

Title (de)

VERBESSERTE MODULARE ANORDNUNG FÜR BODENBELAG

Title (fr)

ENSEMble MODULAIRE PERFECTIONNÉ POUR LA RÉALISATION D'UN REVÊTEMENT DE SOL

Publication

**EP 2828446 A1 20150128 (FR)**

Application

**EP 13711402 A 20130322**

Priority

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Abstract (en)

[origin: WO2013139954A1] The invention relates to an assembly comprising a series of unitary support modules (10) that are assembled to one another to form a lower flat support that can be inserted vertically between the floor and a modular upper cover comprising a series of cover elements (102) which are affixed to the upper surfaces (12) of the unitary support modules (10). The assembly is characterised in that each modular cover element (102) is affixed to the upper surfaces of the unitary support modules (10) using securing means (118, 50) having co-operating complementary shapes and by means of a vertical elastic interlocking arrangement.

IPC 8 full level

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CPC (source: EP US)

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**E04F 2015/02116** (2013.01 - EP US)

Citation (search report)

See references of WO 2013139954A1

Citation (examination)

WO 2007087651 A1 20070802 - GRIMBEEK HENDRIK JAAP [ZA], et al

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FR 1650349 A 20160115; JP 2015500941 A 20130322; US 201314386337 A 20130322